









Release Date: 14 October 2017 Version: A1.1

PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ▶ 7070 0.8t
- ► Warm White 10W (2700K)

N0W38S76





7070 EMC Series





FEATURES:

Package: Top View EMC White Package

Forward Current: 280mA Forward Voltage (typ.): 37.7V

Luminous Flux (typ.): 1160lm@280mA

Colour: Warm White

Colour Temperature (CCT): 2700K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+85°C Storage Temperature: -40~+100°C **Electrostatics Discharge: 5000V**

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 16mm tape with Max. 2000/reel, ø165mm (6.5")

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD
- **Outdoor Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	350	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	Ipf	480	mA
Power Dissipation	P _D	14000	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	125	°C
Electrostatic Discharge	ESD	5000	V
Thermal Resistance (Junction to Solder Point)	R _{тн} з	1.8	°C/W
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

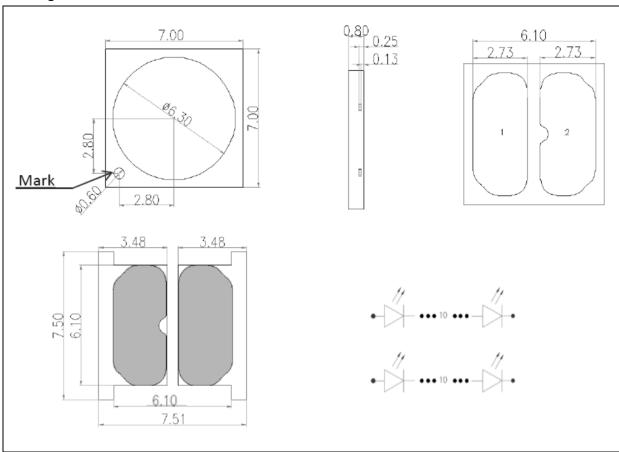
Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	35.0	37.7	40.0	V	I _F =280mA	
Luminous Flux	Ф۷	1000	1160	1300	lm	I _F =280mA	
Chromaticity Coordinates	Х		0.4620			I _F =280mA	
	Υ		0.4145				
Colour Temperature	ССТ	2580	2725	2870	К	I _F =280mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =280mA	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, CRI ±2



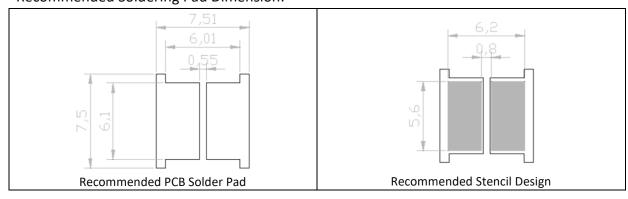
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 280mA):

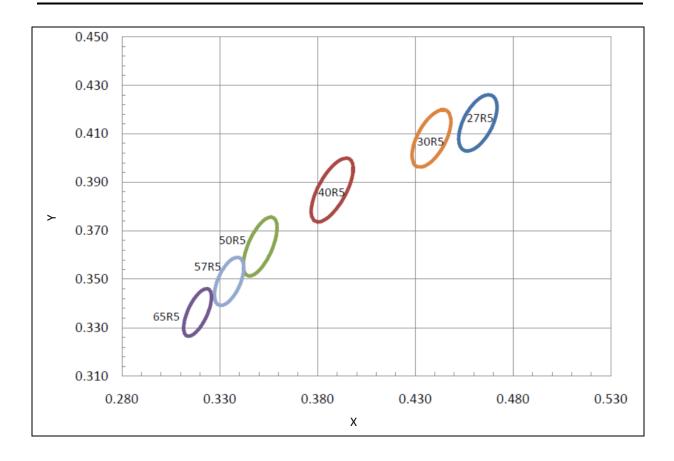
Code	Min.	Max.	Unit
2H	35	36	
2J	36	37	
2K	37	38	V
2L	38	39	
2M	39	40	

Luminous Flux Classifications (I_F = 280mA):

Code	Min.	Max.	Unit
GY	1000	1050	
GZ	1050	1100	
НА	1100	1150	lm
НВ	1150	1200	lm
HC	1200	1250	
HD	1250	1300	



CIE CHROMATICITY DIAGRAM:

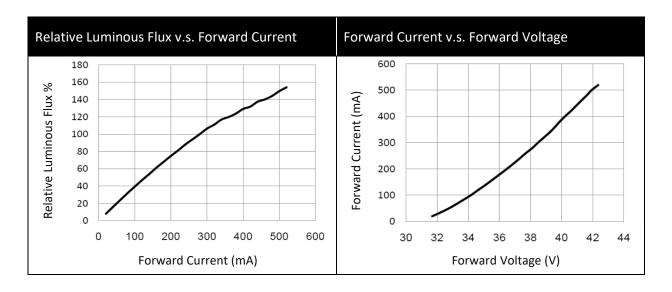


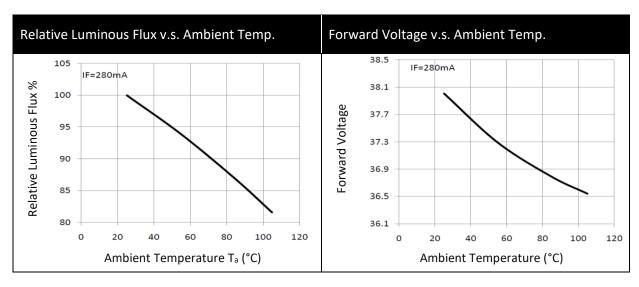
Chromaticity Coordinates Classifications (I_F = 280mA):

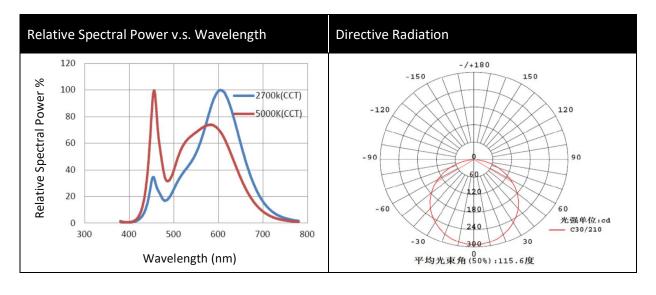
	Code	Centre		Radius		Angle
a /		X	Υ	а	b	Φ
b Ф	27R5	0.4620	0.4145	0.01350	0.00700	53.42



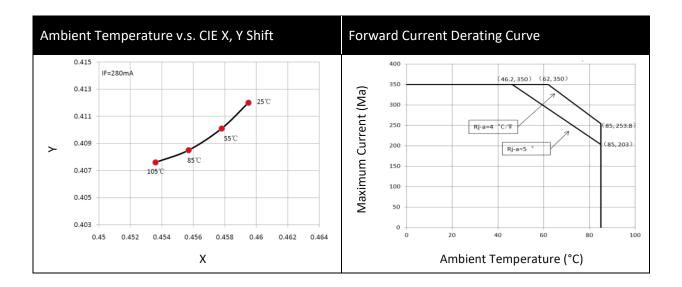
ELECTRO-OPTICAL CHARACTERISTICS:









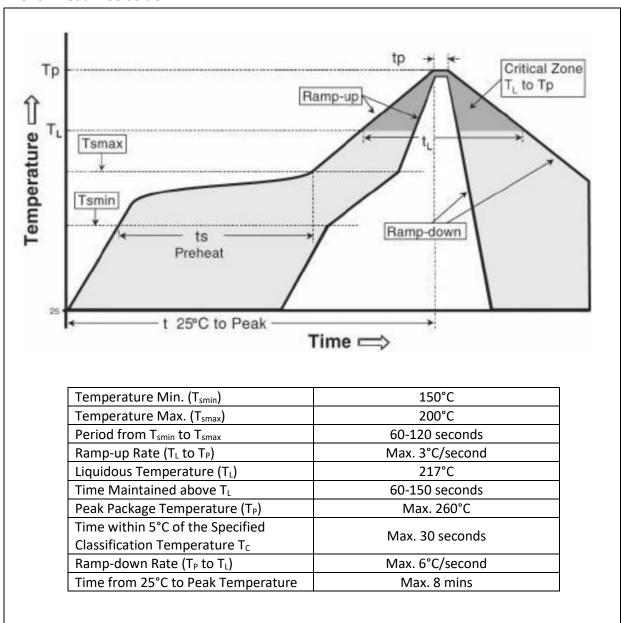


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RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



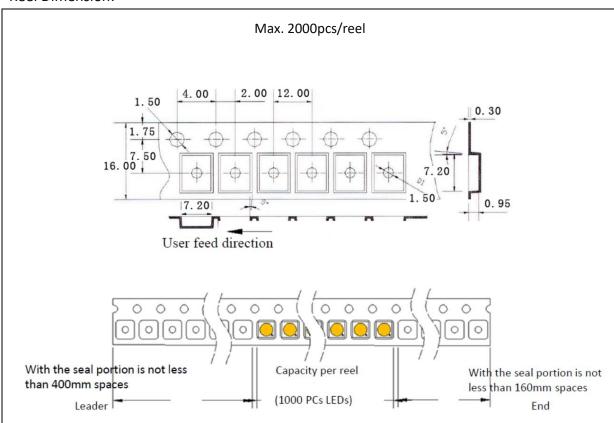
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

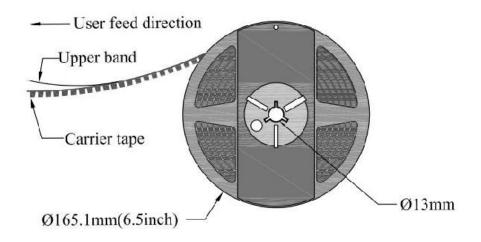


PACKING SPECIFICATION:

Reel Dimension:



- 1. Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ± 0.2 mm
- 2. Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

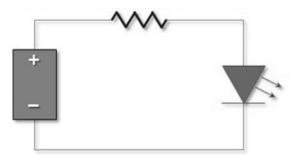
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 65±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	10/03/2017	Datasheet set-up.
A1.1	14/10/2017	Revise wattage.